# SiHA5N80AE

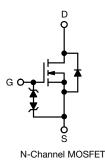
**Vishay Siliconix** 

www.vishay.com

# **E Series Power MOSFET**

#### Thin-Lead TO-220 FULLPAK





PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	1.17			
Q <sub>g</sub> max. (nC)	16.5				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	6				
Configuration	Single				

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA5N80AE-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	800	- V	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous drain surrent $(T_{1} - 150 ^{\circ}\text{C})^{\circ}$	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I <sub>D</sub>	3.0		
Continuous drain current ( $T_J = 150 \ ^\circ C$ ) $^e$	VGS at TO V	T <sub>C</sub> = 100 °C		1.9	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	7	1	
Linear derating factor				0.5	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	17	mJ	
Maximum power dissipation			P <sub>D</sub>	29	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	70	1//20	
Reverse diode dv/dt <sup>d</sup>				0.3	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup> For 10 s				260	°C	
Mounting torque, M3 screw		•		0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.1 A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT HALOGEN

FREE



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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MAX.			UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	65			°C/M			
Maximum junction-to-case (drain)	R <sub>thJC</sub>			°C/W				
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	: 0 V, I <sub>D</sub> = 250 μA	800	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.8	-	V/°C	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 250 \ \mu A$	2	-	4	V	
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 10		
Gate-source leakage	I <sub>GSS</sub>	١	/ <sub>GS</sub> = ± 30 V	-	-	± 50	μA	
		V <sub>DS</sub> =	800 V, V <sub>GS</sub> = 0 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A	-	1.17	1.35	Ω	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 2 A	-	1.2	-	S	
Dynamic					•			
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	321	-	pF	
Output capacitance	C <sub>oss</sub>			-	20	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\text{DS}}$ = 0 V to 480 V, $V_{\text{GS}}$ = 0 V		-	14	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	71	-		
Total gate charge	Qg			-	11	16.5		
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 2 A, V <sub>DS</sub> = 640 V		-	3	-	nC	
Gate-drain charge	Q <sub>gd</sub>			-	6	-		
Turn-on delay time	t <sub>d(on)</sub>			-	12	24		
Rise time	t <sub>r</sub>	$V_{DD}$ = 640 V, $I_D$ = 2 A, $V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	8	16	- ns	
Turn-off delay time	t <sub>d(off)</sub>			-	10	20		
Fall time	t <sub>f</sub>			-	28	56		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		1.6	3.2	6.4	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4		
Pulsed diode forward current	I <sub>SM</sub>			-	-	7	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °(	C, I <sub>S</sub> = 2 A, V <sub>GS</sub> = 0 V	-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>			-	267	534	ns	
		T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 2 A, di/dt = 100 A/µs, V <sub>B</sub> = 25 V						
Reverse recovery charge	Q <sub>rr</sub>			-	1.2	2.4	μC	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

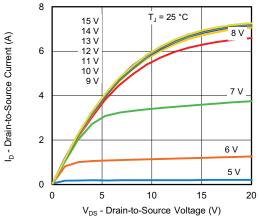


Fig. 1 - Typical Output Characteristics

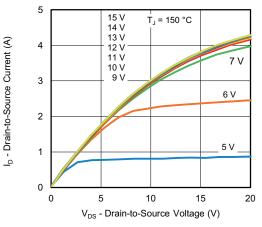


Fig. 2 - Typical Output Characteristics

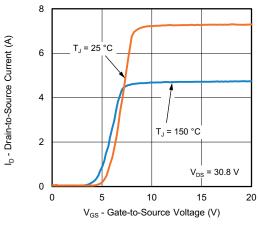


Fig. 3 - Typical Transfer Characteristics

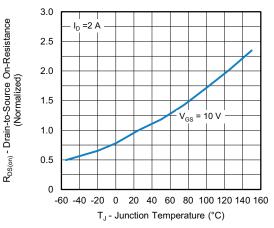


Fig. 4 - Normalized On-Resistance vs. Temperature

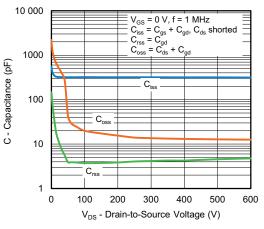
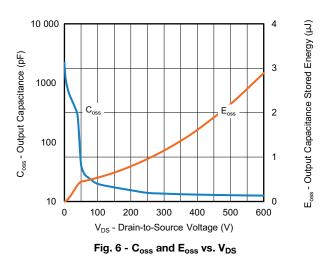


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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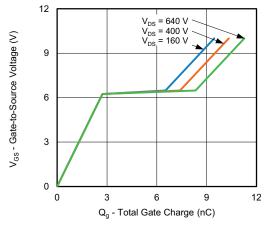


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

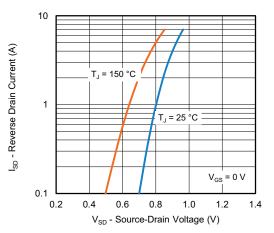


Fig. 8 - Typical Source-Drain Diode Forward Voltage

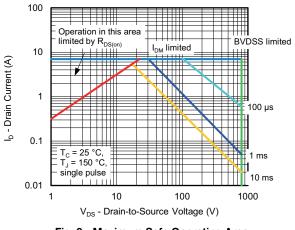


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

T<sub>c</sub> - Case Temperature (°C) Fig. 10 - Maximum Drain Current vs. Case Temperature

4

3

2

1

0

25

50

75

100

125

150

l<sub>D</sub> - Drain Current (A)

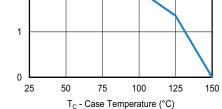
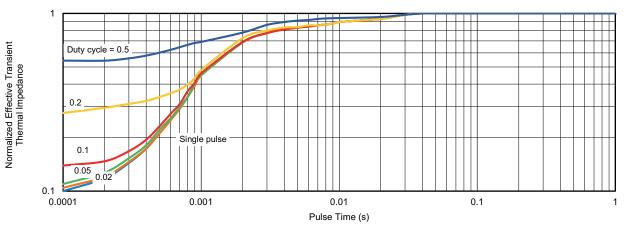
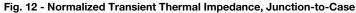


Fig. 11 - Normalized Breakdown Voltage vs. Temperature



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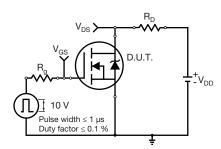


Fig. 13 - Switching Time Test Circuit

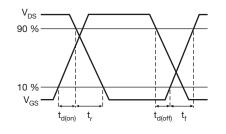


Fig. 14 - Switching Time Waveforms

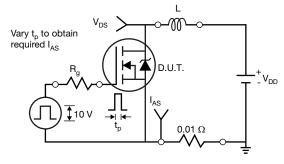


Fig. 15 - Unclamped Inductive Test Circuit

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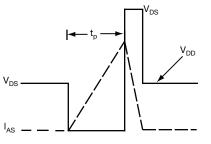


Fig. 16 - Unclamped Inductive Waveforms

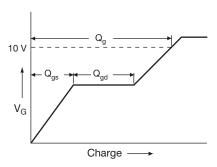
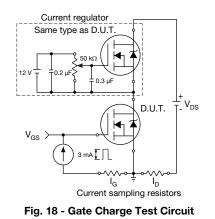


Fig. 17 - Basic Gate Charge Waveform



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#### Peak Diode Recovery dv/dt Test Circuit

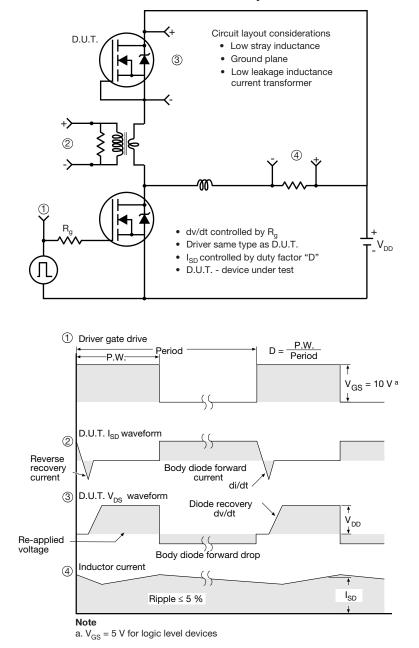


Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





	DIMENSIONS					
SYMBOL	MILLIN	METERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.40	2.80	0.094	0.110		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
С	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.30	3.70	0.130	0.146		
E	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	1.00	2.80	0.039	0.110		
ØP	3.00	3.40	0.118	0.134		
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·			

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